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Transformation Process of the Magnetron-Sputtered Ag_2O Film in Hydrogen Annealing

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Abstract The current paper addresses the effect of the hydrogen partial pressure on the microstructure and transformation of the Ag_2O film. The transformation process and mechanism were also analyzed in detail. Increasing the hydrogen partial pressure can accelerate the transformation of Ag_2O to Ag and lower the critical transformation temperature of the film due to the enhanced hydrogen reduction and to both of the lowered activation energy of the reaction of Ag_2O with hydrogen and enhanced lattice strain of the Ag_2O film. The hydrogen-involved reaction in the whole hydrogen annealing process is mainly hydrogen reduction reaction with Ag_2O . Diffusion of hydrogen and gaseous H_2O molecules accompanies the whole hydrogen annealing process.

Keywords Ag_2O film · Hydrogen annealing · Hydrogen partial pressure · Transformation mechanism

Mathematics Subject Classifications (2010) 74E15 · 74F05 · 74N15 · 74A50

1 Introduction

Ag_xO films have attracted considerable attention because of their potential application in optical and magneto-optical storage. In 1992, Tominaga et al. [1] first reported that

Ag_xO films can be used as substitutes for the organic material commonly used as the storage material in recordable compact discs. Chiu et al. [2] and Kim et al. [3] suggested that Ag_xO can be used as a mask layer in a magneto-optical disc to produce a high-resolution aperture and enhance the magneto-optical signals. In 2003, Zhang et al. [4] discovered the dynamically activated luminescence emission of Ag_xO films, proving that Ag_xO films can be used as nanoscale optical storage materials. According to previous reports, Ag_xO contains several phases, namely, AgO , Ag_2O , Ag_3O_4 [5], Ag_4O_3 [6], and Ag_2O_3 , of which Ag_2O is the most thermodynamically stable. The magnetron-sputtered Ag_xO film is usually biphased (including AgO and Ag_2O phases). However, the use of the Ag_xO film as a new-generation disc material depends on whether it can be used as an optical switch. In 2006, an experiment was performed by Qin et al. [7] to study the ablation of the Ag_xO film under different laser powers. The results suggested that the Ag_xO film can be used as an optical and magneto-optical storage material mainly because of its thermal decomposition reaction. Chuang et al. [8] pointed out that the critical thermal decomposition temperature (CDT) of the AgO and Ag_2O phases are 160 and 380 °C, respectively, whereas Abe et al. [9] found that the CDT of the Ag_2O film deposited via radio-frequency magnetron reactive sputtering is between 200 and 400 °C. Gao et al. [10] previously reported that the Ag_xO film deposited via direct-current magnetron reactive sputtering (DC sputtering) consists of AgO and Ag_2O phases, with CDTs at 200 and 300 °C, respectively. As recently reported by Gao et al. [11], a $\langle 111 \rangle$ preferentially oriented Ag_2O film is deposited on a glass substrate via DC sputtering. The Ag_2O film was then annealed using an optical excitation-assisted rapid thermal annealing under a nitrogen protection condition [12] and a traditional chamber annealing under a

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vacuum condition [13] to determine its thermal stability. In the annealing process, Ag_2O begins to transform into Ag and O_2 at a CDT of approximately 200 °C. In addition, O_2 diffusion is accompanied by the thermal decomposition of Ag_2O .

Hydrogen annealing may play different roles in different films. Liu et al. [14] reported that the electrical property and crystal quality of ZnO films significantly changed after hydrogen annealing. Han et al. [15] reported that hydrogen atoms interstitially couple to oxygen and form hydroxyl (HO^-) ions, resulting in the loss of oxygen during the hydrogen annealing of the $\text{Ti}_{0.93}\text{O}_3$ film. Gao et al. [16] reported that the hydrogen reduction effect can lower the critical transformation temperature (CTT) of Ag_2O to 175 °C at a hydrogen partial pressure ($\text{HPP} = [\text{H}_2]/([\text{Ar}] + [\text{H}_2])$) of 25 %. However, no systematic investigation on the effect of HPP on the microstructure and transformation of the hydrogen-annealed Ag_2O films has been conducted. In addition, using hydrogen annealing is effective to obtain the information on the transformation process and mechanism of Ag_2O . Hence, the current paper focuses on the effect of HPP on the microstructure and transformation of the Ag_2O film and the roles that hydrogen plays in hydrogen annealing to obtain deeper insight into the transformation process and mechanism of the Ag_2O film.

2 Experiment

A single-phase, $\langle 111 \rangle$ -oriented Ag_2O film was first deposited on glass substrates via DC magnetron sputtering at a working pressure of 2.5 Pa, a substrate temperature of 250 °C, and an O_2 -to-Ar flow ratio of 15:18. A high-purity (99.995 %) silver plate was used as the sputtering target. During film deposition, the sputtering power was maintained at 95 W and the electrode distance at 35 mm. Prior to film preparation, the glass substrate was rinsed sequentially with acetone and alcohol in an ultrasonic bath for 15 min, and then placed in an ultrahigh vacuum chamber previously evacuated to a base pressure below 1×10^{-4} Pa. The thickness of the as-deposited Ag_2O film is approximately 920 nm. The Ag target was first pre-sputtered for 5 min before the preparation of Ag_2O film. The gas flow ratio of oxygen to argon was accurately controlled by a mass flow controller. The injected oxygen and Ar were first mixed in a mixer and then injected to the chamber. In addition, the substrate temperature and working pressure were controlled using a thermal coupler and a high-precision vacuum meter, respectively. The as-deposited Ag_2O film was then annealed for 1 h at different HPPs using different hydrogen annealing temperatures (T_a). The chosen HPP values in the hydrogen annealing are 10, 20, 30, 40, and 50 %. The working pressure during hydrogen annealing was maintained at

133 Pa. Afterwards, the films were naturally cooled to room temperature.

The crystalline structure of the film was measured using an X-ray diffractometer (Philips PANalytical X'pert) with a $\text{CuK}\alpha$ ($\lambda = 0.1540598$ nm) as the radiation source. The surface morphology was determined using a cold-field scanning electron microscope (JSM-6700F). All measurements were conducted at room temperature.

3 Results and Discussion

Figure 1 shows the X-ray diffraction patterns of the Ag_2O film hydrogen annealed at different T_a values and at an HPP of 10 %. Wei et al. [17] pointed out that the electrodeposited silver oxide nanostructures have a defective cubic structure containing also amorphous zones. However, no defective cubic structure containing any amorphous zones for the magnetron-sputtered Ag_2O film is observed. The Ag_2O (111) diffraction peak is obviously weakened at $T_a = 160$ °C, and no Ag diffraction peak is discernible. Two weak Ag (111) and (200) diffraction peaks begin to appear at $T_a = 175$ °C, indicating that Ag_2O begins to transform into Ag at this temperature at an HPP of 10 %. Zhang et al. [13] previously reported that under a vacuum condition, the Ag_2O film begins to thermally decompose into Ag nanoparticles at $T_a = 300$ °C via chamber annealing, indicating that hydrogen annealing can lower the CTT of the Ag_2O film. Ag diffraction peaks, rather than Ag_2O diffraction peaks, are discerned at $T_a = 225$ °C.

Figure 2 shows the X-ray diffraction patterns of the Ag_2O film hydrogen annealed at different T_a values using an HPP

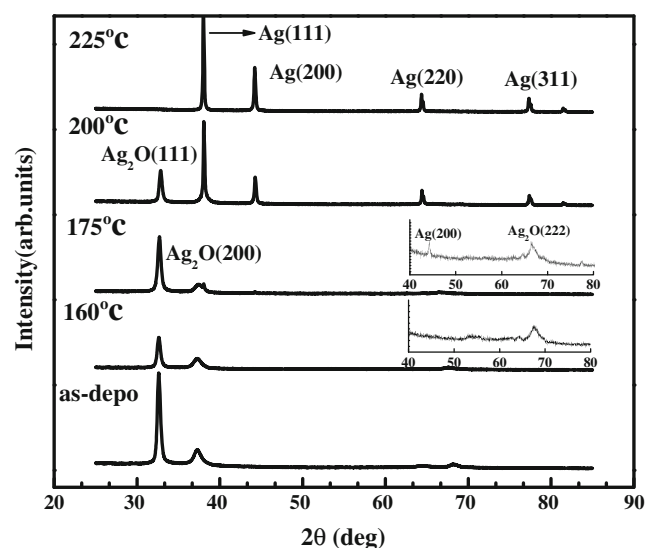


Fig. 1 X-ray diffraction patterns of the Ag_2O film hydrogen annealed at different T_a values using an HPP of 10 %. The two insets display the X-ray diffraction patterns in the 2θ range from 40° to 80°

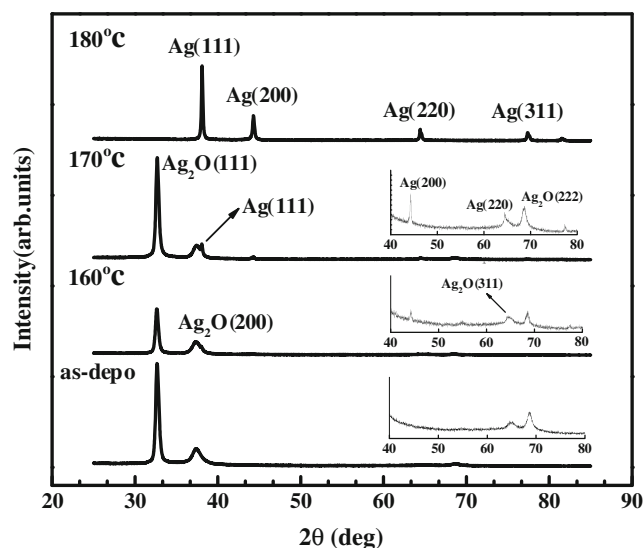


Fig. 2 X-ray diffraction patterns of the Ag_2O film hydrogen annealed at different T_a values using an HPP of 20 %. The three insets display the X-ray diffraction patterns in the 2θ range from 40° to 80°

of 20 %. A similar evolution from Ag_2O to a biphased Ag_2O and Ag complex and to Ag occurs as T_a increases. However, a weak Ag (200) diffraction peak begins to appear at $T_a = 160^\circ\text{C}$. Meanwhile, only Ag diffraction peaks are discerned when T_a is increased to 180°C . Figure 3 shows the X-ray diffraction patterns of the hydrogen-annealed Ag_2O film using an HPP of 30 %. A very weak but clear Ag (200) diffraction peak begins to appear at $T_a = 150^\circ\text{C}$ and becomes strong at $T_a = 160^\circ\text{C}$, at which the Ag_2O diffraction peak is obviously weakened. The Ag_2O diffraction peaks completely disappear at $T_a = 175^\circ\text{C}$. According

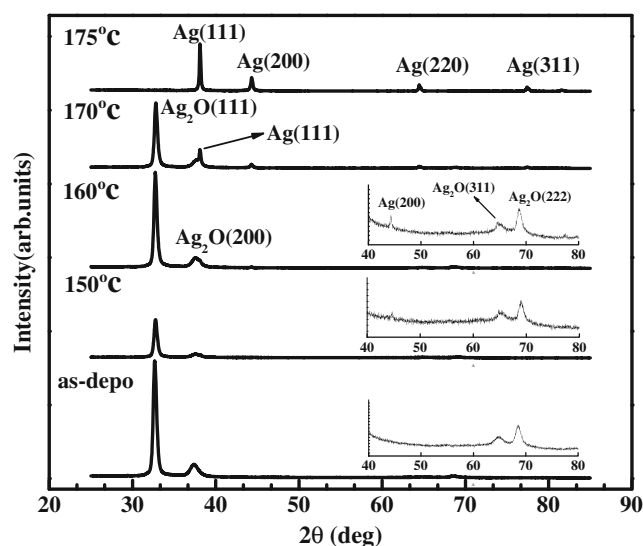


Fig. 3 X-ray diffraction patterns of the Ag_2O film hydrogen annealed at different T_a values using an HPP of 30 %. The three insets display the X-ray diffraction patterns in the 2θ range from 40° to 80°

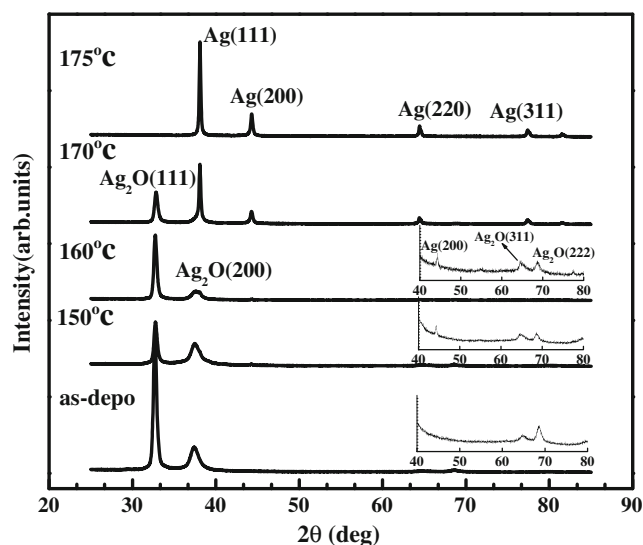


Fig. 4 X-ray diffraction patterns of the Ag_2O film hydrogen annealed at different T_a values using an HPP of 40 %. The three insets display the X-ray diffraction patterns in the 2θ range from 40° to 80°

to the X-ray diffraction results in Figs. 1, 2, and 3, the CTT of the Ag_2O film is reduced from 175 to 150°C as the HPP increases from 10 to 30 %, indicating that increasing the HPP can lower down the CTT of the Ag_2O film. The lowered CTT value with increasing HPP is inherently attributed to the lowered activation energy of the reaction of Ag_2O with hydrogen [18]. In fact, this is a consequence of a great drop in free energy of the reaction system caused by the formation of water [18]. To confirm this result, the Ag_2O film was hydrogen annealed using an HPP of 40 and 50 %. The X-ray diffraction patterns of the Ag_2O

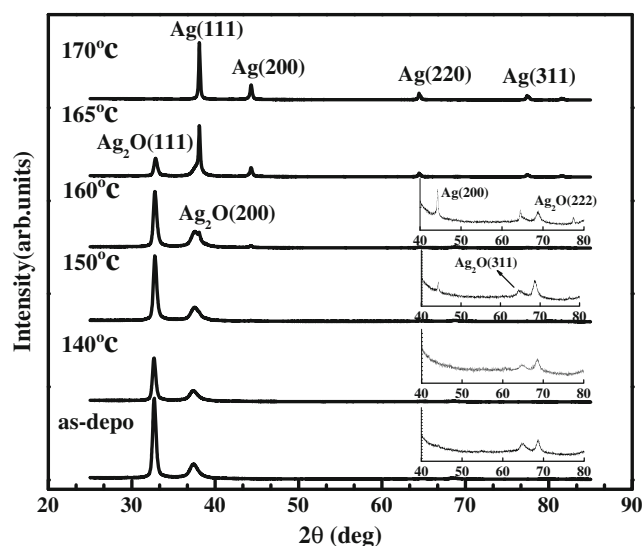
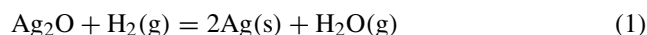


Fig. 5 X-ray diffraction patterns of the Ag_2O film hydrogen annealed at different T_a values using an HPP of 50 %. The four insets display the X-ray diffraction patterns in the 2θ range from 40° to 80°

films are shown in Figs. 4 and 5, respectively. A weak Ag (200) diffraction peak begins to appear at $T_a = 150$ °C (Fig. 4), accompanied by a weakened Ag₂O diffraction peak. The Ag diffraction peaks become much stronger than the Ag₂O diffraction peaks at $T_a = 170$ °C, and only Ag diffraction peaks are discernible at $T_a = 175$ °C. Figure 5 shows the appearance of the Ag (200) diffraction peak at $T_a = 150$ °C, whereas no Ag diffraction peak appears at $T_a = 140$ °C. Notably, only Ag diffraction peaks are discernible at $T_a = 170$ °C. The X-ray diffraction results in Figs. 4 and 5 indicate that the CTT of the Ag₂O film is maintained at 150 °C as the HPP exceeds 30 %. Compared with the results in Figs. 1 to 3, increasing the HPP can accelerate the transformation of Ag₂O to Ag, which is attributed to the reduction role that hydrogen plays in the hydrogen annealing of the Ag₂O film.

Two effects may coexist during the hydrogen annealing process. One is the thermal decomposition of the film because of the thermal effect and the other one is film reduction due to the hydrogen reduction effect. However, the former occurs only at $T_a \geq 200$ °C [16] in the absence of hydrogen. The former may not occur in parallel to the reduction reaction due to the slow thermal decomposition. On the other hand, the enthalpy of adsorption of H atoms on Ag₂O surface exceeds the enthalpy of dissociation of H₂ molecule. Adsorption of H₂ molecules cannot provide enough energy to proceed the dissociation of H₂ molecule on Ag₂O surface [19]. Thereafter, the hydrogen reduction effect involved in the entire hydrogen annealing process is described as follows:



When HPP is increased, more H₂ molecules may be adsorbed on the Ag₂O film surface to accelerate the transformation of Ag₂O to Ag, causing the reduction in the CTT. However, the concentration of the H₂ molecules adsorbed on the film surface may increase to saturation when HPP exceeds 30 %. The transformation of Ag₂O to Ag will no longer be accelerated, causing the CTT to remain unchanged even when HPP further increases.

The decrease in the CTT of Ag₂O may also be attributed to the enhanced lattice distortion of the film besides being due to the lowered activation energy of the reaction of film with hydrogen. Table 1 presents the average grain size and lattice strain of the Ag₂O film, as calculated in accordance with Williamson–Hall relation [20, 21]:

$$\beta \cos \theta = \lambda / D + 4 \times \Delta d / d \times \sin \theta \quad (2)$$

$$\beta^2 = \beta_M^2 + \beta_S^2, \quad (3)$$

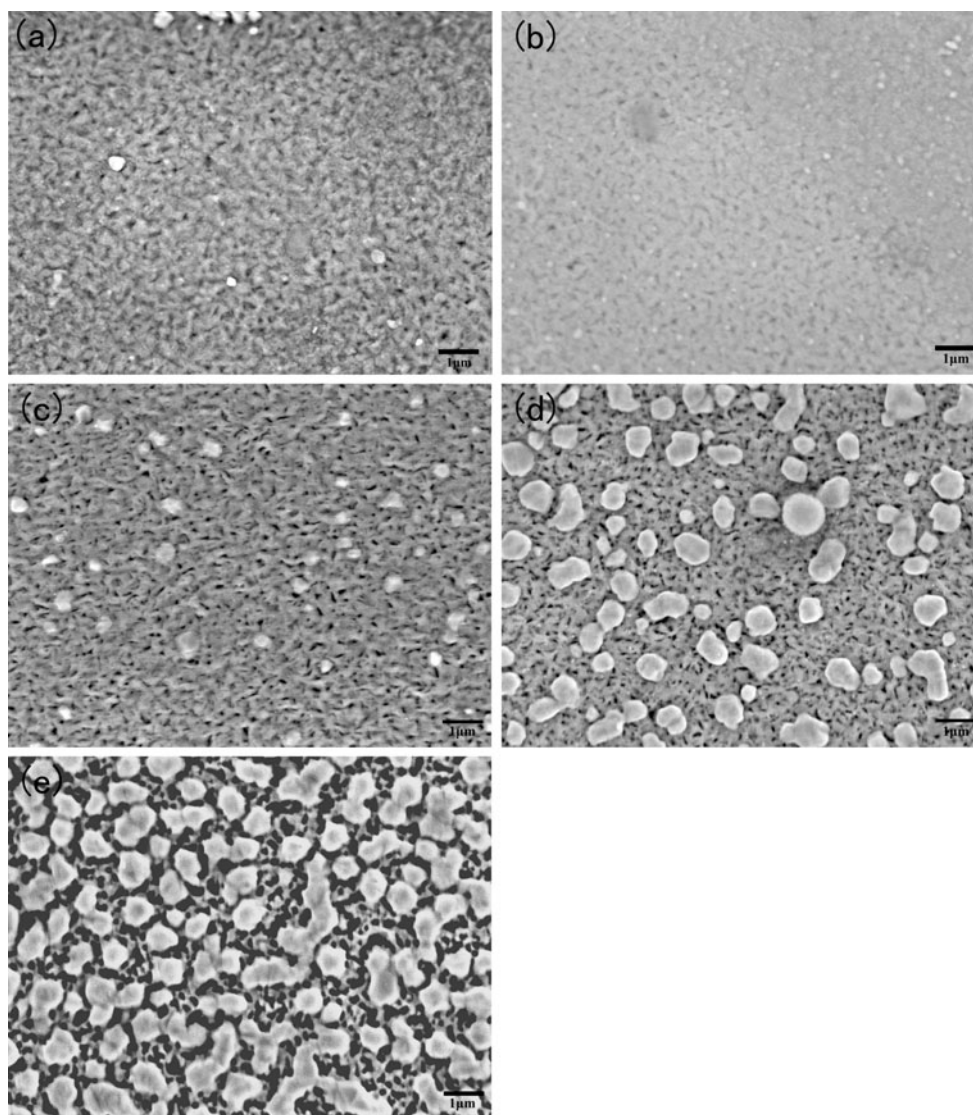
where λ , θ , D , d , and $\Delta d/d$ are the X-ray wavelength, diffraction angle, average grain size, interplanar spacing, and lattice strain, respectively, β is the full width at half

Table 1 Calculated average grain size and lattice strain of the Ag₂O film

HPP (%)	T_a (°C)	Grain size (nm)	Lattice strain (%)
20	As-depo	61.8	0.315
20	160	54.8	0.344
20	170	45.0	0.395
30	As-depo	38.0	0.450
30	150	35.2	0.476
30	160	32.9	0.500
40	As-depo	38.0	0.448
40	150	38.0	0.449
40	160	30.9	0.526
50	As-depo	54.8	0.343
50	140	45.0	0.394
50	150	45.0	0.395
50	160	41.2	0.421

maximum (FWHM) caused by the grain size and the lattice strain, and β_M and β_S are the measured FWHM of film and standard FWHM of the guide sample, respectively. The D and $\Delta d/d$ can be obtained by the linear fitting of $\beta \cos \theta$ vs $\sin \theta$ for all the diffraction peaks in accordance with Williamson–Hall relation, which can be automatically conducted by the software (X'Pert High-Score Plus) accompanied with the XRD instrument (Philips PANalytical X'Pert). The results indicate that a smaller average grain size leads to a larger lattice strain because of the enhanced grain surface effect. The lattice distortion is characterized by the gradually increasing lattice strain with increasing T_a at different HPPs, resulting in a less compact film surface. In this case, the H₂ molecules adsorbed on the Ag₂O film surface may easily diffuse into the loose film and lead to an accelerated transformation of Ag₂O. To confirm this conclusion, the surface morphology of the Ag₂O film hydrogen annealed at different T_a values using an HPP of 10 % was measured using a cold-field scanning electron microscope (Fig. 6). To obtain clear SEM images, carbon was sprayed on the surface of Ag₂O film to enhance the surface conductivity. The Ag₂O film hydrogen annealed at $T_a = 150$ °C shows a compact and uniform surface similar to the surface structure of the as-deposited Ag₂O film. However, the Ag₂O film hydrogen-annealed at $T_a = 175$ °C demonstrates a loose structure, and some holes begin to appear. According to Fig. 1, Ag₂O begins to transform into Ag at $T_a = 175$ °C at an HPP of 10 %. The H₂ molecules adsorbed on the Ag₂O film surface may diffuse through the holes and accelerate the transformation of Ag₂O to Ag via the hydrogen reduction effect. Gaseous H₂O molecules may also diffuse to the film surface through these holes. After hydrogen annealing at 200 and 225 °C, the Ag₂O film surface becomes much looser and more porous,

Fig. 6 Surface morphology of the Ag_2O films hydrogen annealed at temperature of (a) as-depo, (b) 160 °C, (c) 175 °C, (d) 200 °C, and (e) 225 °C



again resulting in the accelerated transformation of Ag_2O to Ag via the hydrogen reduction effect. More gaseous H_2O molecules arising from the hydrogen reduction of the Ag_2O film may also diffuse to the film surface through these holes. Hence, increasing the T_a and HPP may accelerate the transformation of the Ag_2O film. Increasing the HPP up to 30 % may lower the CTT of the Ag_2O film inherently because of the lowered activation energy of the reaction of Ag_2O with hydrogen and the enhanced lattice strain of Ag_2O film. It is worthy to be noted that in subpanels a and c–e of Fig. 6, some agglomerates are discernible whereas none of them appears in Fig. 6b. The surface particle agglomerates may be due to a combination of different effects including not only the transformation of the film but also distortion of the SEM image at the pores. The inherent mechanism is still to be further studied.

4 Conclusions

Ag_2O films preferentially $\langle 111 \rangle$ oriented were deposited on glass substrates via DC magnetron sputtering and then annealed at different temperatures using different HPPs. The main results are as follows:

1. Increasing the HPP and T_a can accelerate the transformation of the Ag_2O film because of the enhanced hydrogen reduction and the enhanced lattice distortion;
2. Increasing the HPP ($\text{HPP} \leq 30\%$) can lower the CTT of the Ag_2O , which is inherently attributed to both the lowered activation energy of the reaction of Ag_2O with hydrogen and the enhanced lattice strain of Ag_2O film. When the HPP surpass 30 %, the CTT will remain unchanged even when HPP further increases.

3. Hydrogen mainly acts as the reducing agent in the hydrogen annealing of the Ag_2O film. The hydrogen-involved reaction in the whole hydrogen annealing process is mainly hydrogen reduction reaction with Ag_2O . In addition, diffusion of hydrogen and gaseous H_2O molecules accompanies the whole hydrogen annealing process.

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